

## Ultra Low Power sub 1GHz Multichannels Radio Transceiver Miniaturized



The **RF-CC1310** module is based on Texas Instruments CC1310F128 component. This device combines a flexible, very low power RF transceiver with a powerful 48 MHz Cortex M3 microcontroller in a platform supporting multiple physical layers and RF standard. Miniaturized version.

Module Information :	Frequency
<b>RF-CC1310</b>	<b>868/915MHz</b>

Sub-1Ghz technology is becoming one of the chief driving forces behind the **Internet of Things (IoT)**, in particular this type of module is ideal for this applications basically for the following reasons :

**Ultra low power consumption**, the consumption of this device is 5.5mA when receiving and 23.5mA when transmitting at +14dBm (13.4mA at +10dBm) in sleep mode the consumption is 0.6µA (microamps).

**Long range operations**, the sensitivity parameter is -110dBm at data rates of 50 kbps and down to -124dBm when the data rate is 0.625kbps.

Interference from other wireless communications can be overcome with 90dB of blocking.

The RF output power levels can reach up to +14dBm.

All this ensure a robust signaling for long range communications.

**SimpleLink-Easylink** compatibility, ultra-low power platform designed (from TI) to easily implement the long-range connectivity with low power consumption on the Internet of Things projects (IoT).

**TI-15.4 Stack**, IEEE802.15.4e/g Standard Based Star Networking Software Designed for long range & robust star networks.

**6LoWPAN** compatibility with mesh network stack for **Contiki**.

### Applications :

- Low-Power Wireless Systems
- Smart Grid and Automatic Meter Reading
- Home and Building Automation
- Wireless Sensor Network
- 6LoWPAN systems

### Feature :

- IEEE 802.15.4g mode switch support
- Ultra Low consumption technology
- Powerful ARM Cortex M3
- Supported by the open platform Contiki 6LoWPAN.
- Very Small size

RF-CC1310-XXX					
Parameter	Symbol	Min.	Typ.	Max.	Units
Operating Voltage	$V_{CC}$	1.8	3.00	3.8	VDC
Supply Current RX Mode	$I_{CRX}$		5.50		mA
Supply Current TX Mode +10dBm	$I_{CTX1}$		13.40		mA
Supply Current TX Mode +14dBm	$I_{CTX2}$		23.50		mA
Supply Current Standby Mode	$I_{CSTB}$		0,70		$\mu$ A
Supply Current Shut Down Mode	$I_{CSHU}$		185		nA
Operative Frequency	$F_{of}$		868/915		MHz
Frequency Error	$F_{pp}$		$\pm 10$		ppm
RF Power Output 50ohm (*)	$P_{oo}$	-10.0		+14.0	dBm
RF Sensibility 50kbps	$S_d$		-110.0		dBm
RF Sensibility Long Range Mode 625bps	$S_{LR}$		-124.0		dBm
Data Rate	$D_{CC}$	0,01		4.0	Mbit/s
Operative Temperature	$T_{LR}$	-30		+75	$^{\circ}$ C

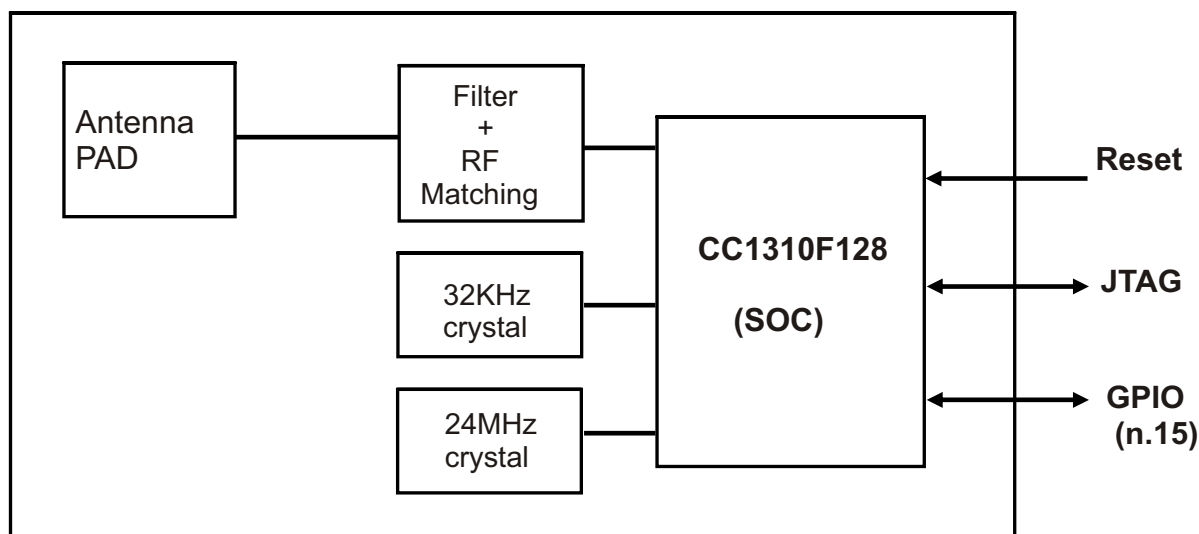
(\*) Programmable parameter.

#### **MICROCONTROLLER:**

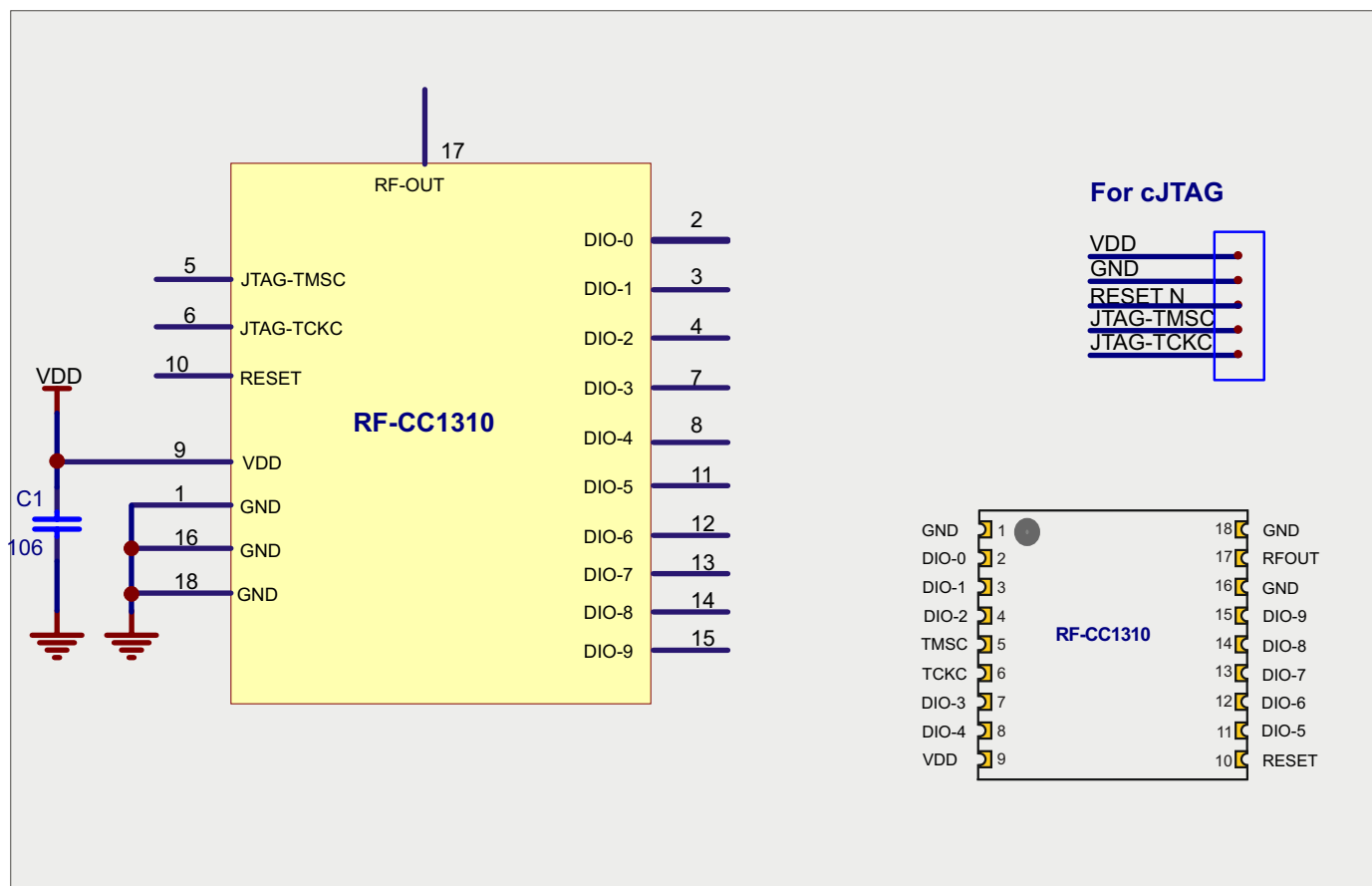
- Power ARM Cortex - M3
- Up to 48MHz Clock Speed
- 128KB of On-System Programming Flash
- 8KB of SRAM for Cache (or as General-Purpose RAM)
- 20KB of Ultralow Leakage SRAM
- Support Over-the-Air Upgrade (OTA)

For more information and details, please refer to the CC1310 Texas Instruments datasheet.

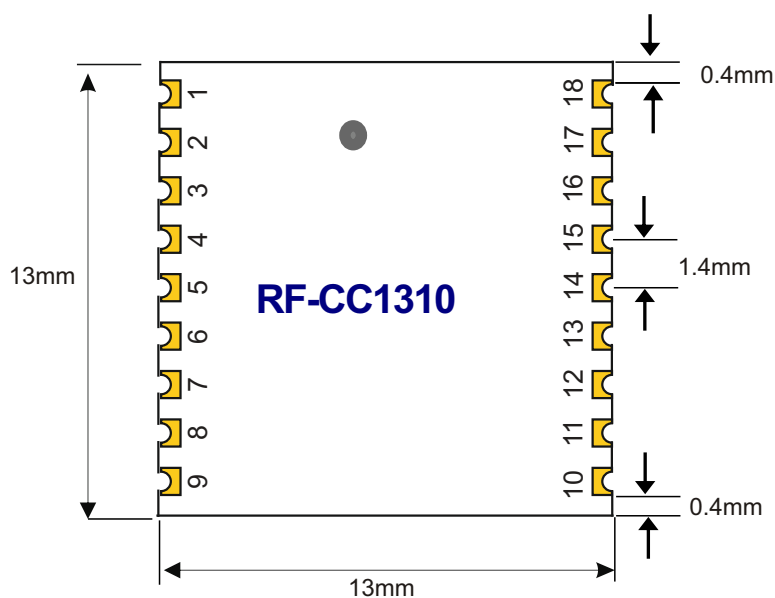
#### **Block Diagram**



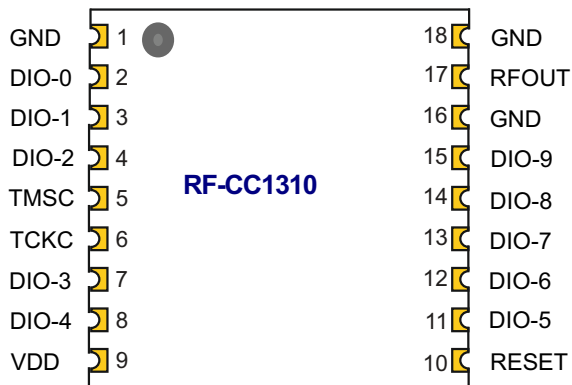
### Reference Schematics



### Mechanical Dimension

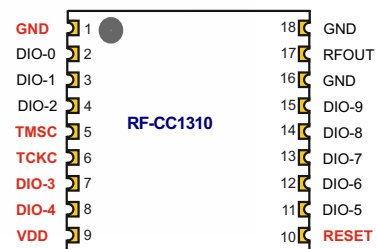
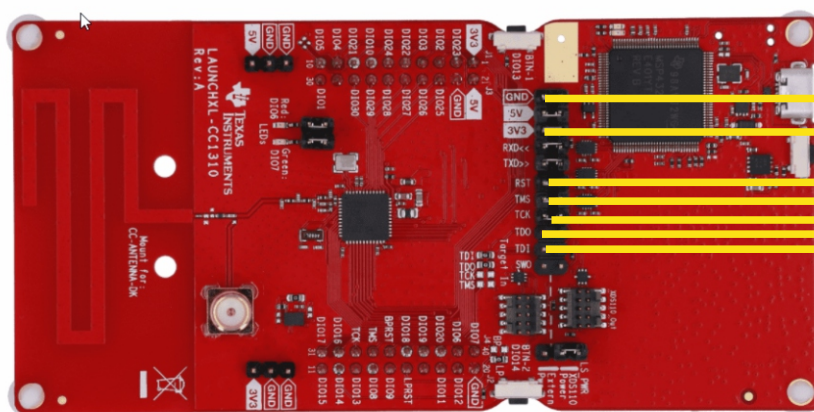


## Terminal description RF-CC1310



Pads	Name	Description
1	GND	Ground
2	DIO-0	GPIO, Sensor Controller
3	DIO-1	GPIO, Sensor Controller
4	DIO-2	GPIO, Sensor Controller, High drive capability
5	JTAG-TMSC	JTAG TMSC, High drive capability
6	JTAG-TCKC	JTAG TCKC
7	DIO-3 -TDO	GPIO, Sensor Controller, High drive capability
8	DIO-4 -TDI	GPIO, Sensor Controller, High drive capability
9	VDD	Power
10	RESET-N	RESET, (Active low)
11	DIO-5	GPIO, High drive capability
12	DIO-6	GPIO, High drive capability
13	DIO-7	GPIO, Sensor Controller, Analog
14	DIO-8	GPIO, Sensor Controller, Analog
15	DIO-9	GPIO, Sensor Controller, Analog
16	GND	Ground
17	ANTENNA	Antenna PAD
18	GND	Ground

## Texas Instruments Launchpad Connection



The diagram illustrates a square unit cell with a side length of 13.0 mm. The cell is composed of a central square region and four rectangular regions at the corners. The central region has a side length of 12.16 mm. The corner regions are defined by a width of 1.40 mm and a height of 1.40 mm. A blue arrow points to the corner region, indicating a magnified view of its internal structure. The magnified view shows a rectangular region with a width of 2.57 mm and a height of 1.6 mm, which is filled with a black material.

Temperature (°C)

250

200

150

100

50

Peak:  $240 \pm 5^\circ\text{C}$

230°C or higher

2°C to 6°C/s

Pre-heating Zone

180°C

150°C

90 ± 30 s

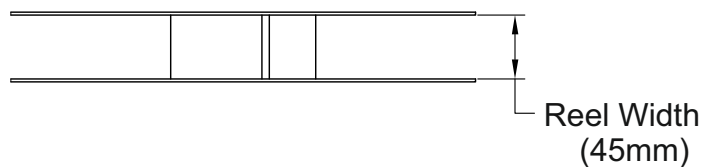
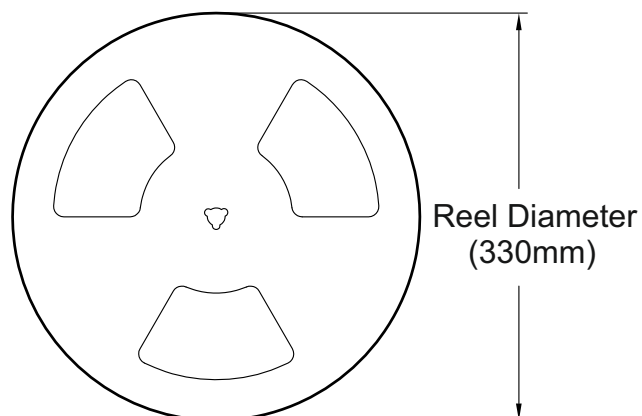
2°C to 4°C/s

20 ± 10 s

Soldering Zone

(3°C to 6°C/s)

Heating time

**REEL DIMENSIONS****TAPE DIMENSIONS**